

LNJ208R8ARA

Surface Mounting Chip LED

SS Type

Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Power dissipation	P_D	50	mW
Forward current	I_F	20	mA
Pulse forward current *	I_{FP}	100	mA
Reverse voltage	V_R	3	V
Operating ambient temperature	T_{opr}	-25 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 to +100	$^\circ\text{C}$

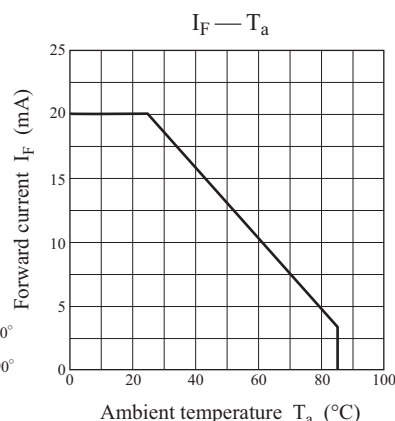
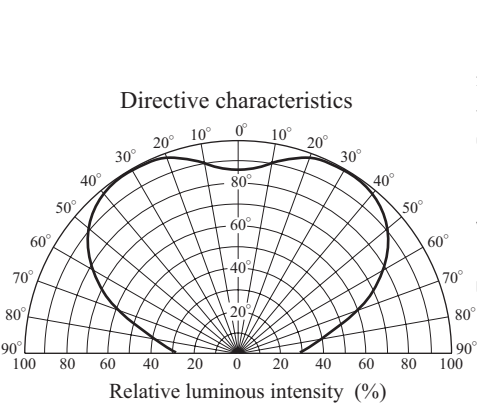
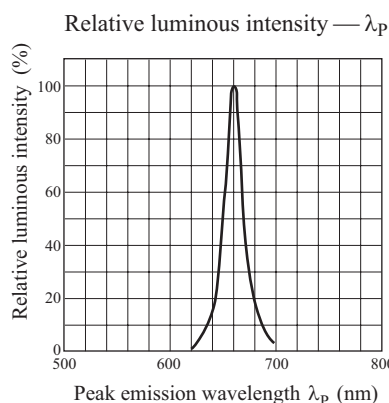
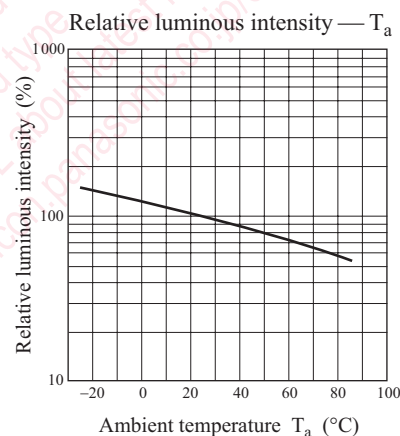
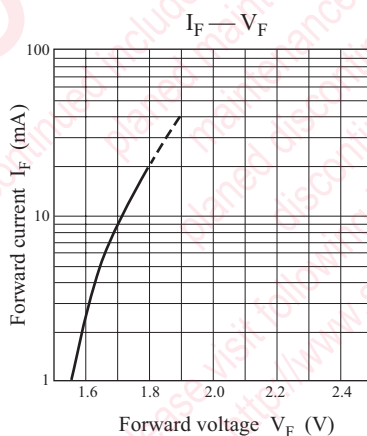
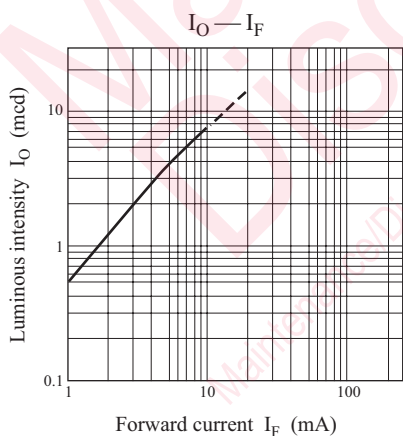
Lighting Color

- Red

Note *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

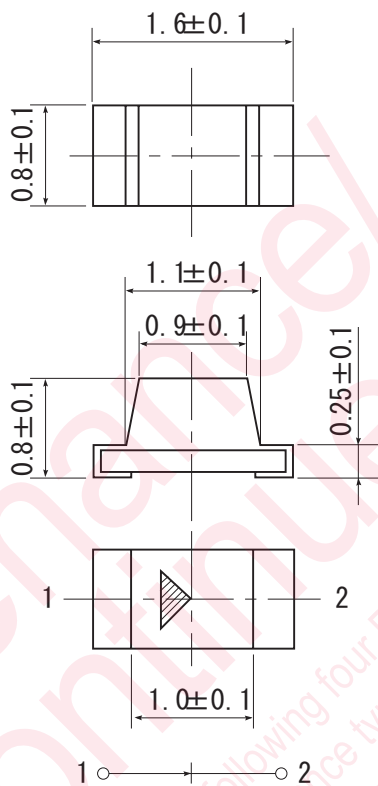
Electro-Optical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity	I_O	$I_F = 10\text{ mA}$	2.75	6.7		mcd
Reverse current	I_R	$V_R = 3\text{ V}$			100	μA
Forward voltage	V_F	$I_F = 10\text{ mA}$		1.72	2.5	V
Peak emission wavelength	λ_p	$I_F = 10\text{ mA}$		660		nm
Spectral half band width	$\Delta\lambda$	$I_F = 10\text{ mA}$		20		nm



■ Package (Unit: mm)

KLTFN2K0800



- Pin name
- 1: Anode
- 2: Cathode

Maintenance/Discontinued includes following four Product lifecycle stage.
planned maintenance type
maintenance type
planned discontinued type
discontinued type
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